ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Composition De 2005. IPC, Bannockt and Pan-American co	claration ourn, Illinois. A opyright conve	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declarati he declaration e	on of the substar ncompasses all le	ces within the n ower level mater	nanufacturer rials for whic	listed item. Not ch the manufactu	e: if the item is an urer has engineerin	assembly with low g responsibility.	
	1 IPC Web Site for Information on IPC-1752 Standard Form			Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi 				ous Materials	ials and Mfg Information			
upplier Information													
ompany name*	Company unique ID			1	Unique ID Authority				Response Date*				
nsemi									2024-05-21				
Contact Name Titl			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Tit			Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards P			Product Enviro Compliance			NA			1	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturi	Manufacturing Site		UOM	Unit Type	
	HCPL26	HCPL2631VM 8PW 10MB		2-CH DIP VDE		2024-05-21		ТНН		590.6827	74 mg	Each	
Ianufacturing Proccess Info	ormation												
Terminal Plating / Grid An	Terminal Plating / Grid Array Material Termin		nal Base Alloy J-STD-020 MSL		L Rating	Peak Proce	Peak Process Body Temperature Max 7		ne at Peak Te	emperature Nu	mber of Reflow C	ycles	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0	0 C :			seconds 3			
omments													
or more information regarding ma	aterial composition	please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	211.509	mg	Supplier	Ethylbenzene	100-41-4		21.1509	mg
			Supplier	Filler (SiO2)	68909-20-6		84.6036	mg
			Supplier	Xylene	1330-20-7		105.7545	mg
Die	0.774713	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0068	mg
			Supplier	Silicon (Si)	7440-21-3		0.7679	mg
Die Attach	0.25	mg	Supplier	Silver (Ag)	7440-22-4		0.2	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0275	mg
			Supplier	Dicyandiamine	461-58-5		0.005	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0175	mg
Lead Frame	114.99	mg	Supplier	Silver (Ag)	7440-22-4		7.2398	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1294	mg
			Supplier	Iron (Fe)	7439-89-6		2.5145	mg
			Supplier	Copper (Cu)	7440-50-8		105.0223	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0839	mg
Mold Compound-Black	251.509	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		50.3018	mg
			Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		6.2877	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		31.4386	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		8.8028	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		125.7545	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		28.9235	mg
Plating	11.6	mg	Supplier	Tin (Sn)	7440-31-5		11.6	mg
Wire Bond - Au	0.05	mg	Supplier	Gold (Au)	7440-57-5		0.05	mg